### HP ProBook 645 G3 Notebook PC

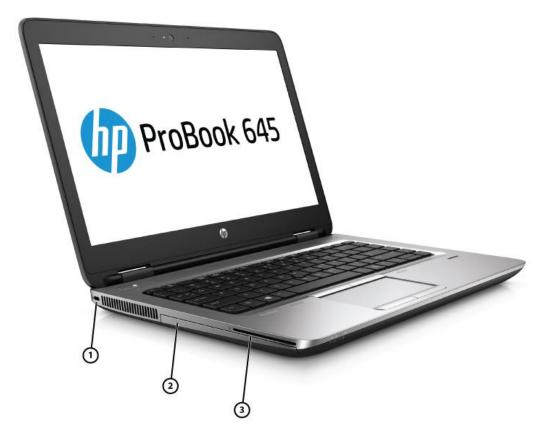


#### Front/Right

- 1. WLAN antennas (2)
- 2. WWAN antennas (2) (select models)
- 3. Internal microphones (2)
- 4. Webcam LED (select models)
- 5. Webcam (select models)
- 6. Wireless on/off button
- 7. Speaker mute button
- 8. Power connector
- 9. SIM card slot
- 10. Docking connector
- 11. Ethernet port
- 12. USB 3.0 ports (2)

- 13. SD card slot
- 14. DisplayPort<sup>™</sup>
- 15. USB-C<sup>™</sup> port
- 16. Microphone/ headphones combo jack
- 17. Fingerprint reader (select models)
- 18. Touchpad
- 19. Touchpad buttons
- 20. Indicator LEDs: Wireless Light, Power Light, AC Adapter/Battery Light, Storage Usage Light
- 21. NFC (select models)
- 22. Pointstick (select models)
- 23. Power button





#### Left side

- 1. Security lock slot
- 2. Optical drive (select models)

3. Smart Card Reader



# Overview



Back

1. VGA port



### HP ProBook 655 G3 Notebook PC

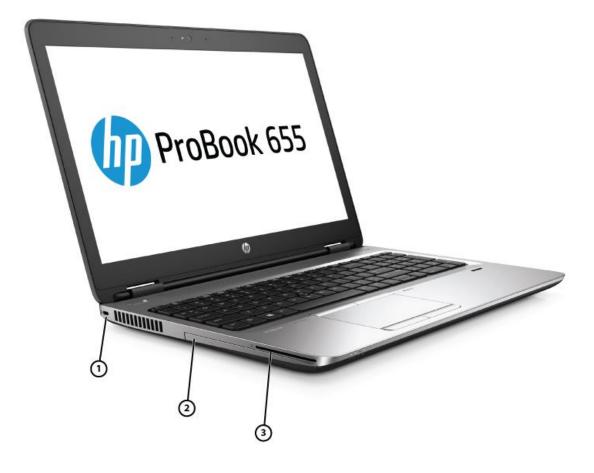


#### Front/Right

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Left side

- 1. Security lock slot
- 2. Optical drive (select models)

3. Smart Card Reader









1. VGA port

2. Serial port (select models)



## AT A GLANCE

- Windows 10 versions, Windows 7 through downgrade rights or FreeDOS 2.0
- Protect existing IT investment with optional optical drive and optional serial port (HP ProBook 655 G3 only)
- Choice of up to 7<sup>th</sup> generation AMD A6, A8 and A10 Accelerated Processing Unit and graphics
- The HP Premium keyboard is spill-resistant and offered with optional backlit design
- Large Touchpad with gestures support, on/off button with LED indicator
- Enhanced security features including TPM 2.0, SmartCard Reader and optional Fingerprint reader
- LED-backlit display HP ProBook 645: 35.56 cm (14") diagonal HD and FHD or Touch FHD with camera and with WWAN HP ProBook 655: 39.6 cm (15.6") diagonal HD and FHD or Touch FHD with camera and with WWAN
- Optional HD webcam with dual-microphone array for video conferencing
- DisplayPort<sup>™</sup> 1.2 with integrated graphics
- Three USB ports for fast data transfer from devices: one standard, one charging, and one USB-C™ charging port
- Wireless and speaker mute button to conveniently manage the connectivity and speaker.
  - Flexible wireless connectivity options:
    - - Broadband Wireless (WWAN)
    - - Wireless LAN (WLAN)
    - - Personal area network (WPAN Bluetooth®)
    - - Near Field Communication (NFC)
    - Choice of hard drives up to 1 TB or solid state drives up to 512 GB
- Pending MIL STD testing<sup>1</sup>

1. MIL STD 810G testing is not intended to demonstrate fitness for U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Damage under the MIL STD test conditions or any accidental damage requires an optional HP Accidental Damage Protection Care Pack.

**NOTE:** See important legal disclosures for all listed specs in their respective features sections.



## **PRODUCT NAMES**

HP ProBook 645 G3 Notebook PC

HP ProBook 655 G3 Notebook PC

### **OPERATING SYSTEM**

Preinstalled	Windows 10 Pro 64 <sup>1</sup>
	Windows 10 Home 64 <sup>1</sup>
	Windows 10 Home Single Language 64 <sup>1</sup>
	Windows 10 Pro 64 (National Academic only) <sup>2</sup>
	NeoKylin Linux 64
	FreeDOS 2.0

Web-only Support

Windows 10 Enterprise<sup>1</sup>

- 1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.
- 2. Some devices for academic use will automatically be updated to Windows 10 Pro Education with the Windows 10 Anniversary Update. Features vary; see https://aka.ms/ProEducation for Windows 10 Pro Education feature information.
- 3. This system is preinstalled with Windows 7 Professional software and also comes with a license and media for Windows 10 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

## PROCESSORS

AMD A10-8730B APU with Radeon<sup>™</sup> R5 Graphics (2.4 GHz, up to 3.3 GHz, 2 MB cache, 4 cores)<sup>1</sup> AMD A8-9600B APU with Radeon<sup>™</sup> R5 Graphics (2.4 GHz, up to 3.3 GHz, 2 MB cache, 4 cores)<sup>1</sup> AMD A6-8530B APU with Radeon<sup>™</sup> R5 Graphics (2.3 GHz, up to 3.2 GHz, 2 MB cache, 2 cores)<sup>1</sup>

#### **Processors Family**

7th Generation AMD A8 APU processor (9600B model) 6th Generation AMD A6 APU processor (8530B model) 6th Generation AMD A10 APU processor (8730B model)

**NOTE:** In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel<sup>®</sup> and AMD 7<sup>th</sup> generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com

1. Multicore is designed to improve performance of certain software products. Not all customers or software applications will



# **Technical Specifications**

necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. AMD's numbering is not a measurement of clock speed.

### CHIPSET

Integrated with processor

### GRAPHICS

Radeon<sup>™</sup> R5 Graphics

**NOTE:** Integrated with processors.

### DISPLAY

#### **HP ProBook 645**

#### Internal

#### Non-Touch

35.56 cm (14") diagonal LED-backlit HD<sup>1</sup> SVA eDP Anti-glare Slim 45% CG 220 nits (1366x768) 35.56 cm (14") diagonal LED-backlit HD<sup>1</sup> SVA eDP Anti-glare Slim 45% CG 220 nits (1366x768) with camera 35.56 cm (14") diagonal LED-backlit HD<sup>1</sup> SVA eDP Anti-glare Slim 45% CG 220 nits (1366x768) with WWAN 35.56 cm (14") diagonal LED-backlit HD<sup>1</sup> SVA eDP Anti-glare Slim 45% CG 220 nits (1366x768) with camera and with WWAN 35.56 cm (14") diagonal LED-backlit FHD SVA eDP Anti-glare Slim 60% CG 300 nits (1920x1080) 35.56 cm (14") diagonal LED-backlit FHD SVA eDP Anti-glare Slim 60% CG 300 nits (1920x1080) with camera 35.56 cm (14") diagonal LED-backlit FHD SVA eDP Anti-glare Slim 60% CG 300 nits (1920x1080) with camera 35.56 cm (14") diagonal LED-backlit FHD SVA eDP Anti-glare Slim 60% CG 300 nits (1920x1080) with camera 35.56 cm (14") diagonal LED-backlit FHD SVA eDP Anti-glare Slim 60% CG 300 nits (1920x1080) with camera 35.56 cm (14") diagonal LED-backlit FHD SVA eDP Anti-glare Slim 60% CG 300 nits (1920x1080) with camera & WWAN 35.56 cm (14") diagonal LED-backlit FHD SVA eDP 60% CG 300 nits (1920x1080) with camera and with WWAN 35.56 cm (14") diagonal LED-backlit FHD SVA eDP 60% CG 300 nits (1920x1080) with camera and with WWAN 400 CG 300 nits (1920x1080) with camera and with WWAN 400 CG 300 nits (1920x1080) with camera and with WWAN 400 CG 300 nits (1920x1080) with camera and with WWAN 400 CG 300 nits (1920x1080) with camera and with WWAN 400 CG 300 nits (1920x1080) with camera and with WWAN 400 CG 300 nits (1920x1080) with camera and with WWAN 400 CG 300 nits (1920x1080) with camera and with WWAN 400 CG 300 nits (1920x1080) with camera and with WWAN 400 CG 300 nits (1920x1080) with camera and with WWAN 400 CG 300 nits (1920x1080) with camera and with WWAN 400 CG 300 nits (1920x1080) with camera and with WWAN 400 CG 300 nits (1920x1080) with camera and with WWAN 400 CG 300 Nits (1920x1080) with camera and with WWAN 400 CG 300 Nits (1920x1080) with camera and WIAN 400 CG 300 CG 300 Nits (1920x1080) WIA CG 300 Nits (

Port supports resolutions up to 1920 x 1200 external resolution @60 Hz

#### DisplayPort 1.2

Supports resolutions up to 2560 x 1600, 30-bit color depth at 60 Hz, and full HD (1920 x 1080) monitors, 24-bit color depth at 120 Hz

#### **Number of Displays Supported**

Supports 3 independent displays if used with optional HP Ultraslim Docking Station<sup>2</sup>

#### HP ProBook 655

Internal Non-Touch 39.6 cm (15.6") diagonal LED-backlit HD<sup>1</sup> SVA eDP Anti-glare Slim 45% CG 220 nits (1366 x 768)



39.6 cm (15.6") diagonal LED-backlit HD<sup>1</sup> SVA eDP Anti-glare Slim 45% CG 220 nits (1366 x 768) with camera 39.6 cm (15.6") diagonal LED-backlit HD<sup>1</sup> SVA eDP Anti-glare Slim 45% CG 220 nits (1366 x 768) with WWAN 39.6 cm (15.6") diagonal LED-backlit HD<sup>1</sup> SVA eDP Anti-glare Slim 45% CG 220 nits (1366 x 768) with camera and with WWAN 39.6 cm (15.6") diagonal LED-backlit FHD SVA eDP Anti-glare Slim 60% CG 300 nits (1920 x 1080) 39.6 cm (15.6") diagonal LED-backlit FHD SVA eDP Anti-glare Slim 60% CG 300 nits (1920 x 1080) 39.6 cm (15.6") diagonal LED-backlit FHD SVA eDP Anti-glare Slim 60% CG 300 nits (1920 x 1080) with camera 39.6 cm (15.6") diagonal LED-backlit FHD SVA eDP Anti-glare Slim 60% CG 300 nits (1920 x 1080) with camera 39.6 cm (15.6") diagonal LED-backlit FHD SVA eDP Anti-glare Slim 60% CG 300 nits (1920 x 1080) with camera

#### Touch

39.6 cm (15.6") diagonal LED-backlit FHD SVA eDP 60% CG 300 nits (1920 x 1080) with camera with WWAN **External** 

Up to 32-bit per pixel color depth

VGA

Port supports resolutions up to 1920 x 1200 external resolution @60 Hz

#### DisplayPort™ 1.2

Supports resolutions up to 2560 x 1600, 30-bit color depth at 60 Hz, and full HD (1920 x 1080) monitors, 24-bit color depth at 120 Hz

#### Number of Displays Supported

Supports 3 independent displays if used with optional HP Ultraslim Docking Station<sup>2</sup>

NOTE: Resolutions are dependent upon monitor capability, and resolution and color depth settings.

- 1. HD content required to view HD images.
- 2. Sold separately or as an optional feature.

### **STORAGE AND DRIVES**

Primary Storage Bay SATA, 2.5" Hard Drives<sup>1</sup> 500 GB 7200 rpm 500 GB 7200 rpm Self-Encrypting Drive (Opal 2) 500 GB 7200 rpm Self Encrypting Drive (FIPS-140-2) 1 TB 5400 rpm

#### M.2 (NGFF) Solid State Drive<sup>1</sup>

128 GB SATA-3 SS Value 256 GB-PCIe NVMe SSD TLC 256 GB-SATA TLC (Opal 2) 512 GB-PCIe NVMe TLC 360 GB PCIe Gen3x4 NVMe SS TLC 256 GB PCIe Gen3x4 NVMe SS Value 512 GB PCIe Gen3x4 NVMe SS Value

1. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB of system disk is reserved for system recovery software.

### **OPTICAL DRIVES**

Fixed 9.5 mm SATA



## **Technical Specifications**

DVD-ROM Drive DVD+/-RW SuperMulti DL<sup>1</sup> BD Writer

1. Intended for your original content and other lawful uses. Don't copy copyright-protected materials.

2. Not available on with Touch panel.

### MEMORY

DDR4-2133 SDRAM (Transfer rates up to 1866 MT/s) Two SODIMM slots supporting dual-channel memory

#### Configurations

4096 MB Total System Memory (4096 MB x 1) 8192 MB Total System Memory (4096 MB x 2) 8192 MB Total System Memory (8192 MB x 1) 12288 MB Total System Memory (8192 MB + 4096 MB) 16384 MB Total System Memory (8192 MB x 2)

#### Maximum

Up to 16384 MB

#### **Dual-channel**

Maximized dual-channel performance requires SODIMMs of the same size and speed in both memory slots.

**NOTE:** Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

### **NETWORKING/COMMUNICATIONS**

#### Broadband Wireless (WWAN)<sup>2,3</sup>

HP lt4120 Qualcomm<sup>®</sup> Snapdragon™ X5 LTE Mobile Broadband Module HP lt4132 LTE/HSPA+ 4G Mobile Broadband Module HP hs3210 HSPA+ Mobile Broadband Module

#### Wireless LAN (WLAN)<sup>1,2</sup>

Options via Minicard Intel® Dual Band Wireless-AC 3168 802.11 a/b/g/n/ac (1x1) Wi-Fi® and Bluetooth® 4.2 Combo (non-vPro) Realtek 802.11b/g/n (1x1) and Bluetooth® 4.0 Combo (non-vPro) Intel® Dual Band Wireless-AC 7265 802.11a/b/g/n/ac (2x2) WiFi and Bluetooth® 4.2 Combo (non-vPro)

#### Personal area network (WPAN Bluetooth)<sup>1,2</sup>

Bluetooth® 4.0 supported via Broadcom Realtek Bluetooth® 4.2 supported via all supported Intel® WLAN modules

#### Near Field Communication (NFC) Optional<sup>2</sup>



HP Module with NXP NFC Controller NPC100

1. Wireless access point and Internet service is required and is not included. Availability of public wireless access points limited.

2. Sold separately or as an optional feature.

3. WWAN module is optional and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.

#### Support for Miracast (Windows 10)

Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming media players that also support Miracast. You can use Miracast to share what you're doing on your PC and present a slide show. For more information: http://windows.microsoft.com/en-us/windows-8/project-wireless-screen-miracast.

#### Communications

Realtek RTL8111HSH Gigabit Ethernet NIC with DASH Support

### AUDIO/MULTIMEDIA

#### Audio

(2) Integrated stereo speakers Dual Array Microphone

#### Webcam

Optional 720p HD webcam<sup>1,2</sup>

- 1. Sold separately or as an optional feature.
- 2. HD content required to view HD images.

## **KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS**

#### **HP Premium Keyboard**

The HP spill-resistant keyboard is designed using a thin layer of Mylar film under the keyboard. The 101/102-key compatible keyboard features a full-pitch key layout with desktop keyboard features, such as editing keys, both left and right control and alt keys, and function keys. DuraKeys only available with Backlit option.

#### **Three Keyboard Options**

Touchpad, Spill-resistant with drain Touchpad, Spill-resistant with drain, DuraKeys & Backlit Dual Point, Spill-resistant with drain, DuraKeys & Backlit

#### Touchpad

On/Off button Enabled by default 2F Scrolling – On 2F Zoom ( Pinch ) – On OSD ( enable / disable ) – On



#### **Buttons and Function Keys**

- F1 Sleep
- F2 Blank
- F3 Backlit
- F4 Display Switch
- F5 Brightness down
- F6 Brightness up
- F7 Blank
- F8 Volume down
- F9 Volume up
- F10 Mic Mute
- F11 Bank
- F12 Num lock

### SOFTWARE AND SECURITY

#### Preinstalled Software with Windows Operating System

#### BIOS

HP BIOSphere<sup>1</sup> HP DriveLock | HP Automatic DriveLock BIOS Update via Network Master Boot Record Security Power On Authentication Secure Erase<sup>2</sup> Absolute Persistence Module<sup>3</sup> Pre-boot Authentication

#### Multi Media

CyberLink Power Media Player - CMIT CyberLink Power2Go

#### **Communication / Connectivity**

HP Mobile Connect Pro (Windows 10 only)<sup>5</sup> Native Miracast Support<sup>6</sup> HP LAN-WLAN Protection HP MAC Address Manager HP SureConnect

#### **HP Value Add Software**

HP 3D DriveGuard 6 HP ePrint Driver + JetAdvantage<sup>7</sup> HP Hotkey Support - CMIT



## **Technical Specifications**

HP Recovery Manager

- HP Recovery Disc Creator (Windows 7 only)
- HP Jumpstart
- HP Support Assistant
- HP Noise Cancellation Software

#### 3<sup>rd</sup> Party

Foxit PhantomPDF Express for HP (Windows 7 only)

#### **Microsoft Products**

Buy Office Bing Search Skype<sup>8</sup>

#### Manageability

HP Driver Packs<sup>9</sup> HP SoftPaq Download Manager (SDM)<sup>9</sup> HP System Software Manager (SSM)<sup>9</sup>HP BIOS Config Utility (BCU)<sup>9</sup>HP Client Catalog<sup>9</sup>HP MIK for Microsoft SCCM<sup>9</sup> LANDESK Management<sup>10</sup> For more information on HP Client Management Solutions refer to: http://www.hp.com/go/clientmanagement.

#### **Client Security Software**

HP Client Security Suite Gen3

- HP Security Manager (including Credential Manager and Password Manager)
- HP Drive Lock
- HP Fingerprint Sensor
- HP Password Manager
- Absolute Persistence Module
- Power On Authentication

Microsoft Security Essentials<sup>11</sup> (Windows 7 only) Microsoft Defender (Windows 10 only)

#### Security

Trusted Platform Module (TPM) 1.2 (Infineon SLB9670). Common Criteria EAL4+ Certified. Upgradable to TPM 2.0. Convertible to FIPS 140-2 Certified mode. (TPM 2.0 is not available for Win 7 32-bit.) HP Fingerprint reader (On select models) Security lock slot (Cable not included) Integrated Smart Card Reader

1 Available only on business PCs with HP BIOS.

2. For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88.

3. Absolute agent is shipped turned off, and will be activated when customers activate a purchased



## **Technical Specifications**

subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit: http://www.absolute.com/company/legal/agreements/ computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.

4. This product ships with TPM 1.2 with option to upgrade to TPM 2.0. Upgrade utility is expected to be available by the end of 2016 via HP Customer Support

5. HP Mobile Connect Pro is only available on preconfigured devices with WWAN. For geographic availability refer to http://www.hp.com/go/mobileconnect

6. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming media players that also support Miracast. You can use Miracast to share what you're doing on your PC and present a slide show. For more information: http://windows.microsoft.com/en-us/windows-8/project-wireless-screen-miracast

7. Requires an Internet connection to HP web-enabled printer and HP ePrint account registration (for a list of eligible printers, supported documents and image types and other HP ePrint details, see <a href="http://www.hp.com/go/eprintcenter">http://www.hp.com/go/eprintcenter</a>). 8. Skype is not offered in China.

9. Not preinstalled, however available for download at http://www.hp.com/go/clientmanagement 10. Subscription required.

11. Opt in and internet connection required for updates.

### POWER

#### Power Supply<sup>1</sup>

HP 45W Smart AC Adapter HP 45W Smart AC Adapter (2 prong) HP 65W Smart AC Adapter HP 65W Smart EM Adapter

#### 1. Availability may vary by country.

#### Power cord

Power cord included is 1.8 m (+/- 0.1 m) or 1.0 m (+/- 0.1 m).

#### **Primary Battery**

HP 3-cell Long Life Prismatic (48 WHr)

**NOTE:** Battery is internal and not replaceable by customer.

#### Battery Life<sup>1</sup>

Platform	Other HW Details	Battery	UMA Graphics
HP ProBook 645 G3	HDD	3-cell (48WHr)	Up to 8 hrs
HP ProBook 645 G3	SSD	3-cell (48WHr)	Up to 9 hrs 15 mins
HP ProBook 655 G3	HDD	3-cell (48WHr)	Up to 7 hrs 45 mins



	HP ProBook 655 G3	SSD	3-cell (48WHr)	Up to 9 hrs 30 mins	
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### System Standby Time<sup>2</sup>

TBD

 Windows 10 MM14 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details.
 Standby life will vary depending on various factors including battery, Memory, CPU, EC and LAN chip. The maximum capacity of the battery will naturally decrease with time and usage.

### **WEIGHTS & DIMENSIONS**

#### HP ProBook 645 Notebook PC

**Weight** Starting at 4.30 lbs (1.95 kg)<sup>1</sup> (3-cell battery, ODD weight saver, UMA, no FPR, 1 SODIMM, WLAN only, SSD, touchpad only, no camera, no WWAN)

**Dimensions** (w x d x h) 13.39 x 9.33 x 1.06 in (Front and rear)<sup>2</sup> 34.0 x 23.7 x 2.70 cm (Front and rear)<sup>2</sup>

#### HP ProBook 655 Notebook PC Weight

Starting at 5.10 lbs ( 2.31 kg)<sup>1</sup> (3-cell battery, ODD weight saver, UMA, no FPR, 1 SODIMM, WLAN only, SSD, touchpad only, no camera, no WWAN)

**Dimensions** (w x d x h) 14.88 x 10.11 x 1.08 in (Front and rear)<sup>2</sup> 37.8 x 25.70 x 2.74 cm (Front and rear)<sup>2</sup>

1. Weight varies by configuration and components.

2. Height varies depending upon where on the notebook the measurement is made.

## **PORTS/SLOTS**

Ports 1 USB Type-C<sup>™</sup> 1 USB 3.0 port 1 USB 3.0 port charging



- 1 RJ-45 / Ethernet
  1 Docking connector
  1 Headphone / Microphone (Combo jack )
  1 AC port (4.5mm)
  1 DisplayPort<sup>™</sup> 1.2
  1 VGA port
  1 Optional Serial port (Only available on HP ProBook 655)<sup>1</sup>
- 1. Sold separately or as an optional feature.

**SD Media Reader Slot** Supports SD, SDHC, SDXC

## **SERVICE AND SUPPORT**

HP Services offers 3-year and 1-year limited warranties and 90 day software support options depending on country. Batteries have a default one year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform. On-site service<sup>1,2</sup> and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc.

- 1. Sold separately or as an optional feature.
- 2. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc

## DISPLAYS

**Note:** All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

14.0" diagonal FHD AG WLED SVA 60%cg 300nits eDP Slim Touch	
Active Area (W x H)	309.40 x 173.95 (mm)
Dimensions (W x H)	320.9 x 205.6 (mm) max
Diagonal Size	14 (inch)
Thickness	3.0 (mm) max
Weight	430 g max



## HP ProBook 645 G3 Notebook PC HP ProBook 655 G3 Notebook PC

# **Technical Specifications**

Interface	eDP 1.2
Surface Treatment	BV
Contrast Ratio	300:1 (typical)
Refresh Rate	60 Hz
Brightness	300 nits
Pixel Resolution - Format	1920 x 1080 (FHD)
PPI	157
Pixel Resolution - Configuration	RGB
Backlight	LED
Color Gamut Coverage	60%
Color Depth	6 bits + Hi FRC
Viewing Angle	SVA 45/45/25/35
Touch Enabled	Optional
Other Features	AS
Pen Enabled	No
14.0" FHD AG WLED SVA 60%cg 300nits eDP Slim	
Active Area (W x H)	309.40 x 173.95 (mm)
Dimensions (W x H)	320.9 x 205.6 (mm) max
Diagonal Size	14 (inch)
Thickness	3.0 (mm) max
Weight	270 g max
Interface	eDP 1.2
Surface Treatment	Anti-Glare (AG)
Contrast Ratio	300:1 (typical)
Refresh Rate	60 Hz
Brightness	300 nits
Pixel Resolution - Format	112
PPI	1920 x 1080 (FHD)
Pixel Resolution - Configuration	RGB
Backlight	LED
Color Gamut Coverage	60%
Color Depth	6 bits + Hi FRC
Viewing Angle	SVA 45/45/25/35
Touch Enabled	Optional
Other Features	AS
Pen Enabled	No

#### 14.0" diagonal HD AG WLED SVA 45%cg 220nits eDP Slim Active Area (W x H)



Not all configuration components are available in all regions/countries. c05240727 – DA 15673– World Wide – Version 8 – September 12, 2018

309.40 x 173.95 (mm)

# Technical Specifications

reenned Speemed lons	
Dimensions (W x H)	320.9 x 205.6 (mm) max
Diagonal Size	14 (inch)
Thickness	3.0 (mm) max
Weight	290 g max
Interface	eDP 1.2
Surface Treatment	Anti-Glare (AG)
Contrast Ratio	300:1 (typical)
Refresh Rate	60 Hz
Brightness	220 nits
Pixel Resolution - Format	112
PPI	1366 x 768 (HD)
Pixel Resolution - Configuration	RGB
Backlight	LED
Color Gamut Coverage	45%
Color Depth	6 bits + Hi FRC
Viewing Angle	SVA 45/45/25/35
Touch Enabled	Optional
Other Features	AS
Pen Enabled	No
15.6" diagonal FHD AG WLED SVA 60%cg 300nits eDP Slim 3.2mm Touch	
Active Area (W x H)	344.2 x 193.5 (mm)
Dimensions (W x H)	360 x 224.3 (mm) max
Diagonal Size	15.6 (inch)
Thickness	3.2 (mm) max
Weight	550 g max
Interface	eDP 1.2
Surface Treatment	BV
Contrast Ratio	400:1 (typical)
Refresh Rate	60 Hz
Brightness	300 nits
Pixel Resolution - Format	142
PPI	1920 x 1080 (FHD)
Pixel Resolution - Configuration	RGB
Backlight	LED
Color Gamut Coverage	60%
Color Depth	6 bits
Viewing Angle	SVA 45/45/25/35
Other Features	10-point multi-touch
Pen Enabled	AS



## HP ProBook 645 G3 Notebook PC HP ProBook 655 G3 Notebook PC

# **Technical Specifications**

15.6" FHD AG WLED SVA 60%cg 300nits eDP Slim 3.2mm	
Active Area (W x H)	344.2 x 193.5 (mm)
Dimensions (W x H)	360 x 224.3 (mm) max
Diagonal Size	15.6 (inch)
Thickness	3.2 (mm) max
Weight	360 g max
Interface	eDP 1.2
Surface Treatment	Anti-Glare (AG)
Contrast Ratio	400:1 (typical)
Refresh Rate	60 Hz
Brightness	300 nits
Pixel Resolution - Format	101
PPI	1920 x 1080 (FHD)
Pixel Resolution - Configuration	RGB
Backlight	LED
Color Gamut Coverage	60%
Color Depth	6 bits
Viewing Angle	SVA 45/45/25/35
Other Features	AS
Pen Enabled	Νο
15.6" diagonal HD AG WLED SVA 45%cg 220nits eDP Slim	
Active Area (W x H)	344.2 x 193.5 (mm)
Active Area (W x H) Dimensions (W x H)	344.2 x 193.5 (mm) 360 x 224.3 (mm) max
Active Area (W x H) Dimensions (W x H) Diagonal Size	344.2 x 193.5 (mm) 360 x 224.3 (mm) max 15.6 (inch)
Active Area (W x H) Dimensions (W x H) Diagonal Size Thickness	344.2 x 193.5 (mm) 360 x 224.3 (mm) max 15.6 (inch) 3.2 (mm) max
Active Area (W x H) Dimensions (W x H) Diagonal Size Thickness Weight	344.2 x 193.5 (mm) 360 x 224.3 (mm) max 15.6 (inch) 3.2 (mm) max 370 g max
Active Area (W x H) Dimensions (W x H) Diagonal Size Thickness Weight Interface	344.2 x 193.5 (mm) 360 x 224.3 (mm) max 15.6 (inch) 3.2 (mm) max 370 g max eDP 1.2
Active Area (W x H) Dimensions (W x H) Diagonal Size Thickness Weight Interface Surface Treatment	344.2 x 193.5 (mm) 360 x 224.3 (mm) max 15.6 (inch) 3.2 (mm) max 370 g max eDP 1.2 Anti-Glare (AG)
Active Area (W x H) Dimensions (W x H) Diagonal Size Thickness Weight Interface Surface Treatment Contrast Ratio	344.2 x 193.5 (mm) 360 x 224.3 (mm) max 15.6 (inch) 3.2 (mm) max 370 g max eDP 1.2 Anti-Glare (AG) 300:1 (typical)
Active Area (W x H) Dimensions (W x H) Diagonal Size Thickness Weight Interface Surface Treatment Contrast Ratio Refresh Rate	344.2 x 193.5 (mm) 360 x 224.3 (mm) max 15.6 (inch) 3.2 (mm) max 370 g max eDP 1.2 Anti-Glare (AG) 300:1 (typical) 60 Hz
Active Area (W x H) Dimensions (W x H) Diagonal Size Thickness Weight Interface Surface Treatment Contrast Ratio Refresh Rate Brightness	344.2 x 193.5 (mm) 360 x 224.3 (mm) max 15.6 (inch) 3.2 (mm) max 370 g max eDP 1.2 Anti-Glare (AG) 300:1 (typical) 60 Hz 220 nits
Active Area (W x H) Dimensions (W x H) Diagonal Size Thickness Weight Interface Surface Treatment Contrast Ratio Refresh Rate Brightness Pixel Resolution - Format	344.2 x 193.5 (mm) 360 x 224.3 (mm) max 15.6 (inch) 3.2 (mm) max 370 g max eDP 1.2 Anti-Glare (AG) 300:1 (typical) 60 Hz 220 nits 101
Active Area (W x H) Dimensions (W x H) Diagonal Size Thickness Weight Interface Surface Treatment Contrast Ratio Refresh Rate Brightness Pixel Resolution - Format PPI	344.2 x 193.5 (mm) 360 x 224.3 (mm) max 15.6 (inch) 3.2 (mm) max 370 g max eDP 1.2 Anti-Glare (AG) 300:1 (typical) 60 Hz 220 nits 101 1366 x 768 (HD)
Active Area (W x H) Dimensions (W x H) Diagonal Size Thickness Weight Interface Surface Treatment Contrast Ratio Refresh Rate Brightness Pixel Resolution - Format PPI	344.2 x 193.5 (mm) 360 x 224.3 (mm) max 15.6 (inch) 3.2 (mm) max 370 g max eDP 1.2 Anti-Glare (AG) 300:1 (typical) 60 Hz 220 nits 101 1366 x 768 (HD) RGB
Active Area (W x H) Dimensions (W x H) Diagonal Size Thickness Weight Interface Surface Treatment Contrast Ratio Refresh Rate Brightness Pixel Resolution - Format PPI Pixel Resolution - Configuration Backlight	344.2 x 193.5 (mm) 360 x 224.3 (mm) max 15.6 (inch) 3.2 (mm) max 370 g max eDP 1.2 Anti-Glare (AG) 300:1 (typical) 60 Hz 220 nits 101 1366 x 768 (HD) RGB LED
Active Area (W x H) Dimensions (W x H) Diagonal Size Thickness Weight Interface Surface Treatment Contrast Ratio Refresh Rate Brightness Pixel Resolution - Format PPI Pixel Resolution - Configuration Backlight Color Gamut Coverage	344.2 x 193.5 (mm) 360 x 224.3 (mm) max 15.6 (inch) 3.2 (mm) max 370 g max eDP 1.2 Anti-Glare (AG) 300:1 (typical) 60 Hz 220 nits 101 1366 x 768 (HD) RGB LED 45%
Active Area (W x H) Dimensions (W x H) Diagonal Size Thickness Weight Interface Surface Treatment Contrast Ratio Refresh Rate Brightness Pixel Resolution - Format PPI Pixel Resolution - Configuration Backlight	344.2 x 193.5 (mm) 360 x 224.3 (mm) max 15.6 (inch) 3.2 (mm) max 370 g max eDP 1.2 Anti-Glare (AG) 300:1 (typical) 60 Hz 220 nits 101 1366 x 768 (HD) RGB LED



### **STORAGE**

HDD 500 GB 7200RPM 7mm SATA		
Capacity		500GB
Drive Weight		0.20-0.21 lbs (92-95 g)
Rotation Speed		7200 rpm
Cache Buffer		Up to 32MB
NAND Type/Size		N/A
Height		7mm
Width		69.85mm
Interface		ATA-8, SATA 3.0
Interface Transfer Rate		600 MB/s
	Single Track	1.5-2 ms
Seek Time	Average	11-13 ms
	Maximum	18-22 ms
Logical Blocks		976,773,168
Operating Temperature		32° to 140° F (0° to 60° C) [top cover temp]
Security Features		ATA Security
Other Features		S.M.A.R.T., NCQ, Ultra DMA

HDD 500GB 7200RPM 7mm FIPS SATA Opal2	
Capacity	500 GB
Drive Weight	0.21 lbs (95 g)
Rotation Speed	7200 rpm
Cache Buffer	32 MB
NAND Type/Size	N/A
Height	0.28 in (7 mm)
Width	2.75 in (69.85 mm)
Interface	ATA-8, SATA 3.0
Interface Transfer Rate	600 MB/s



# **Technical Specifications**

	Single Track	1.5 ms
Seek Time	Average	12 ms
	Maximum	21 ms
Logical Blocks		976,773,168
Operating Temperature		32° to 140° F (0° to 60° C) [top cover temp]
Security Features		ATA Security; TCG Opal 2.x, FIPS
Other Features		S.M.A.R.T., NCQ, Ultra DMA
HDD 500GB 7200RPM 7mm SED SATA (	)pal2	
Capacity		500 GB
Drive Weight		0.21 lbs (95 g)
Rotation Speed		7200 rpm
Cache Buffer		32 MB
NAND Type/Size		N/A
Height		0.28 in (7 mm)
Width		2.75 in (69.85 mm)
Interface		ATA-8, SATA 3.0
Interface Transfer Rate		600 MB/s
	Single Track	1.5 ms
Seek Time	Average	12 ms
	Maximum	21 ms
Logical Blocks		976,773,168
Operating Temperature		32° to 140° F (0° to 60° C) [top cover temp]
Security Features		ATA Security; TCG Opal 2.x
Other Features		S.M.A.R.T., NCQ, Ultra DMA

SSD 128GB 2280 M2 SATA-3 Value	
Form-Factor (I/O)	M.2 2280
Capacity	128 GB
NAND Type	MLC/TLC
Weight	0.01-0.02 lb (6-10 g)
Height	0.09 in (2.3 mm)
Width	0.87 in (22 mm)
Interface	ATA-8, SATA 3.0
Sequential Read	520 ~ 535 MB/s



# Technical Specifications

Sequential Write	185 ~ 515 MB/s
Logical Blocks	250,069,680
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
Security Features	ATA Security (Option)
Other Features	DIPM; TRIM; DEVSLP
SSD 256GB 2280 M2 PCIe-3x4 SS NVMe TLC	
Form-Factor (I/O)	M.2 2280
Capacity	256 GB
NAND Type	TLC
Weight	0.02 lb (10 g)
Height	0.09 in (2.3 mm)
Width	0.87 in (22 mm)
Interface	PCIe NVMe Gen3X4
Sequential Read	1,800 ~2,600 MB/s
Sequential Write	600 900 MB/s
Logical Blocks	500,118,192
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
Security Features	ATA Security (Option)
Other Features	TRIM; L1.2
SSD 512GB 2280 M2 PCIe-3x4 SS NVMe TLC	
Form-Factor (I/O)	M.2 2280
Capacity	512 GB
NAND Type	TLC
Weight	0.02 lb (10 g)
Height	0.09 in (2.3 mm)
Width	0.87 in (22 mm)
Interface	PCIe NVMe Gen3X4
Sequential Read	1,580 ~ 2,600 MB/s
Sequential Write	300 ~ 1,400 MB/s
Logical Blocks	1,000,215,216
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
Security Features	ATA Security (Option)
Other Features	TRIM; L1.2

SSD 256GB 2280 M2 SATA-3 Self Encrypted OPAL2 Three Layer Cell	
Form-Factor (I/O)	M.2 2280
Capacity	256 GB



NAND Type	TLC
Weight	0.02 lb (10 g)
Height	0.09 in (2.3 mm)
Width	0.87 in (22 mm)
Interface	ATA-8, SATA 3.0
Sequential Read	515 ~ 530 MB/s
Sequential Write	490 ~ 515 MB/s
Logical Blocks	500,118,192
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
Security Features	ATA Security; TCG Opal 2.0
Other Features	DIPM; TRIM; DEVSLP
SSD 360GB 2280 PCIe-3x4 SS NVMe TLC	
Form-Factor (I/O)	M.2 2280
Capacity	360 GB
NAND Type	TLC
Weight	0.02 lb (10 g)
Height	0.09 in (2.3 mm)
Width	0.87 in (22 mm)
Interface	PCIe NVMe Gen3X4
Sequential Read	1,700 MB/s (Compressible Performance)
Sequential Write	600 MB/s (Compressible Performance)
Logical Blocks	703,282,608
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
Security Features	ATA Security (Option)
Other Features	TRIM; L1.2
256 GB PCIe Gen3x4 NVMe SS Value Solid State Drive	
Form-Factor (I/O)	M.2 2280
Capacity	256 GB
NAND Type	TLC
Weight	0.02 lb (10 g)
Height	0.09 in (2.3 mm)
Width	0.87 in (22 mm)
Interface	PCIe NVMe Gen3X4
Sequential Read	1,700 MB/s (Compressible Performance)
Sequential Write	600 MB/s (Compressible Performance)
Logical Blocks	500,118,192



# Technical Specifications

Security Features ATA Security (Option)
Other Features TRIM; L1.2
512 GB PCIe Gen3x4 NVMe Value Solid State Drive
Form-Factor (I/O) M.2 2280
Capacity 512 GB
NAND Type TLC
Weight         0.02 lb (10 g)
<b>Height</b> 0.09 in (2.3 mm)
Width         0.87 in (22 mm)
Interface PCIe NVMe Gen3X4
Sequential Read 1,700 MB/s (Compressible Performance)
Sequential Write 600 MB/s (Compressible Performance)
Logical Blocks 1,000,215,216
Operating Temperature32° to 158°F (0° to 70°C) [ambient temp]
Security Features ATA Security (Option)
Other Features TRIM; L1.2

## **OPTICAL DRIVES**

	Access Times	Random	<140ms CD (typical) < 160ms DVD (typical)
	Weight	150g max.	
	Max Data Transfer Rate	24X CD-ROM 8X DVD-ROM	
		5X DVD-RAI	
		UDMA Mode	2 5
DVDROM Drive	Interface	Gen 1 SATA	
	Supported Media (read)	CD, CD-I, CD Multisessio R, CD-RW), (	TEXT, CD-ROM, CD-ROM XA, MIXED MODE I-I Bridge (Photo-CD, Video CD), n CD (Photo-CD, CD-EXTRA, Portfolio, CD- CD-R, CD-RW, DVD-ROM (DVD-5, DVD-9, 'D-18), DVD-R, DVD-RW, DVD+R, VD-RAM
	<b>Max Media Capacity</b> (read)	8.5 GB	
	Transport	Tray Loadin	g
DVD+/-RW SuperMulti DL Drive	Access Times	Random	<140ms CD (typical)



# **Technical Specifications**

		< 160ms DVD (typical)
Weight	150g max.	
	24X CD-ROM	
	8X DVD-ROM	l
	24X CD-R	
	10X CD-RW	
	8X DVD+R	
Max Data Transfer Rate	8X DVD+RW	
	8X DVD-R	
	6X DVD-RW	
	6X - DVD+R [	Dual Layer
	6X - DVD-R D	Dual Layer
	5X DVD-RAM	L
Transfer Mode	UDMA Mode	5
Interface	Gen 1 SATA	
Supported Media (read)	CD, CD-I, CD- Multisession R, CD-RW), C	EXT, CD-ROM, CD-ROM XA, MIXED MODE I Bridge (Photo-CD, Video CD), CD (Photo-CD, CD-EXTRA, Portfolio, CD- D-R, CD-RW, DVD-ROM (DVD-5, DVD-9, )-18), DVD-R, DVD-RW, DVD+R, 'D-RAM
Supported Media (write)		I, DVD+R, DVD+RW, DVD-R, DVD-RW, VD+R DL, DVD-R DL
<b>Max Media Capacity</b> (read)	8.5 GB	
<b>Max Media Capacity</b> (write)	8.5 GB	
Transport	Tray Loading	I
		<200ms CD (typical)
Access Times	Random	<200ms DVD (typical)
		<250ms BD (typical)
Weight	150g max.	
-	24X CD-ROM	
	8X DVD-ROM	I
	6X BD-ROM	
Max Data Transfer Rate	24X CD-R	
	10X CD-RW	
	8X DVD+R	
	8X DVD+RW	

**BD** Drive



# Technical Specifications

	8X DVD-R 6X DVD-RW 6X - DVD+R Dual Layer 6X - DVD-R Dual Layer 5X DVD-RAM 4X BD-R 2X BD-RE
Transfer Mode	UDMA Mode 5
Interface	Gen 1 SATA
Supported Media (read)	CD-DA, CD-TEXT, CD-ROM, CD-ROM XA, MIXED MODE CD, CD-I, CD-I Bridge (Photo-CD, Video CD), Multisession CD (Photo-CD, CD-EXTRA, Portfolio, CD- R, CD-RW), CD-R, CD-RW, DVD-ROM (DVD-5, DVD-9, DVD-10, DVD-18), DVD-R, DVD-RW, DVD+R, DVD+RW, DVD-RAM, BD-ROM, BD-R, BD-RE
Supported Media (write)	CD-R, CD-RW, DVD+R, DVD+RW, DVD-R, DVD-RW, DVD-RAM, DVD+R DL, DVD-R DL, BD-R, BD-RE
<b>Max Media Capacity</b> (read)	128 GB
<b>Max Media Capacity</b> (write)	128 GB
Transport	Tray Loading

### NETWORKING

Technology/Operating bands	LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3),
	1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8),
	700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 17 lower),
	800 (Band 20), 700 (Band 28).
	HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4),
	850 (Band 5), 900 (Band 8) MHz
	EV-DO: 850 (BC0), 1900 (BC1) MHz (Only work with Verizon network)
	E-GPRS: 1900 (Band 2), 1800 (Band 3), 850 (Band 5), 900 (Band 8)

# **Technical Specifications**

	MHz
Wireless protocol standards	3GPP Release 10 LTE Specification CAT.4, 20MHz BW WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification
	1xEVDO Release 0, A and B.
	E-GPRS: Class B, Multi-slot class 12, coding schemes CS1 - CS4
	and MSC1 - MSC9
GPS	Standalone, A-GPS (MS-A, MS-B and XTRA)
GPS bands	1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz
Maximum data rates	LTE: 150 Mbps (Download), 50 Mbps (Upload)
	DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload)
	HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)
	CDMA 1xRTT: 153.6 kbps (Download), 153.6 kbps (Upload)
	EVDO Rel.A: 3.1 Mbps (Download), 1.8 Mbps (Upload)
	EVDO Rel.B: 14.7 Mbps (Download), 5.4Mbps (Upload)
	EDGE: 236.8 kbps (Download), 236.8 kbps (Upload)
	GPRS: 85.6 kbps(Download), 85.6 kbps (Upload)
Maximum output power	LTE: 23 dBm
	HSPA+: 23.5 dBm
	1xRTT/EVDO: 24dBm
	E-GPRS 1900/1800: 26 dBm
	E-GPRS 900/850: 27 dBm
	GPRS 1900/1800: 29.5 dBm
	GPRS 900/850: 32.5 dBm
Maximum power consumption	LTE: 1,200 mA (peak); 900 mA (average)
	HSPA+: 1,100 mA (peak); 800 mA (average)
	1xRTT/EVD0: 1,000 mA (peak); 700 mA (average)



# **Technical Specifications**

E-GPRS: 2,800 mA (peak); 500 mA (average)

Form Factor	M.2, 3042-S3 Key B
Weight	6.2 g
<b>Dimensions</b> (Length x Width x Thickness)	42 x 30 x 2.3 mm

\* Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all area provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and o not available on all products or in all countries.

	HP lt4132 LTE/HSPA+ 4G Mobile Broadband Module
Technology/Operating bands	LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3) MHz,
	850 (Band 5), 2600 (Band 7), 900 (Band 8) MHz,
	800 (Band 20), 700 (Band 28) MHz.
	HSPA+: 2100 (Band 1), 1900 (Band 2), 850 (Band 5), 900 (Band 8) MHz
	E-GPRS: 1900 (Band 2), 1800 (Band 3), 850 (Band 5), 900 (Band 8) MHz
Wireless protocol standards	3GPP Release 10 LTE Specification CAT.4, 20MHz BW WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification
	E-GPRS: Class B, Multi-slot class 12, coding schemes CS1 - CS4
	and MSC1 - MSC9
GPS	Standalone, A-GPS (MS-B and LTO)
GPS bands	1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz
Maximum data rates	LTE: 150 Mbps (Download), 50 Mbps (Upload)
	DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload)
	HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)
	EDGE: 236.8 kbps (Download), 236.8 kbps (Upload)
	GPRS: 85.6 kbps(Download), 85.6 kbps (Upload)



# **Technical Specifications**

Maximum output power	LTE: 23 dBm
	HSPA+: 23.5 dBm
	E-GPRS 1900/1800: 26 dBm
	E-GPRS 900/850: 27 dBm
	GPRS 1900/1800: 29.5 dBm
	GPRS 900/850: 32.5 dBm
Maximum power consumption	LTE: 1,200 mA (peak); 900 mA (average)
	HSPA+: 1,100 mA (peak); 800 mA (average)
	E-GPRS: 2,600 mA (peak); 500 mA (average)
Form Factor	М.2, 3042-S3 Кеу В
Weight	6 g
<b>Dimensions</b> (Length x Width x Thickness)	42 x 30 x 2.3 mm

\* Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all area provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and c not available on all products or in all countries.

#### HP hs3210 HSPA+ Mobile Broadband Module\*

Technology/Operating bands	HSPA+: 2100 (Band1), 1900 (Band 2), 850 (Band 5), 900 (Band 8) MHz E-GPRS: 1900 (Band 2), 1800 (Band 3), 850 MHz (Band 5), 900 (Band 8) MHz
Wireless protocol standards	WCDMA R99, 3GPP Release 5, 6 and 7 UMTS Specification
	E-GPRS: Class B, Multi-slot class 33, coding schemes CS1 - CS4 and MSC1 - MSC9
Maximum data rates	HSPA+: 21.6 Mbps (Download), 5.76 Mbps (Upload)
	E-GPRS: 296 kbps (Download), 236.8 kbps (Upload) GPRS: 107 kbps (Download), 85.6 kbps (Upload)



Maximum output power	HSPA+: 24 dBm E-GPRS 1800/1900: 26 dBm E-GPRS 850/900: 27 dBm GPRS 1800/1900: 30 dBm GPRS 850/900: 33 dBm
Maximum power consumption	HSPA+: 1,100 mA (peak); 800 mA (average)
	E-GPRS: 2,800 mA (peak); 700 mA (average)
Form Factor	M.2, 2242-S3 Key B
Weight	6 g
<b>Dimensions</b> (Length x Width x Thickness)	1.65 x 8.66 x 0.09 in (42 x 22 x 2.38 mm)

\* Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors.

#### Intel® Dual Band Wireless-AC 3168 802.11 a/b/g/n/ac (1x1) Wi-Fi® and Bluetooth® 4.2 Combo

Wireless LAN Standards	IEEE 802.11a
	IEEE 802.11b IEEE 802.11g
	IEEE 802.11n
	IEEE 802.11ac
Interoperability	Wi-Fi certified
Frequency Band	802.11b/g/n
	<ul> <li>2.402 – 2.482 GHz Note:</li> </ul>
	The FCC has declared as of January 1, 2015 pro passive scanning on channel 12/13 and are cap

The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

802.11a/n



Data Rates	<ul> <li>4.9 – 4.95 GHz (Japan)</li> <li>5.15 – 5.25 GHz</li> <li>5.25 – 5.35 GHz</li> <li>5.47 – 5.725 GHz</li> <li>5.825 – 5.850 GHz Note: Indonesia only supports 5.725 - 5.825 GHz (CH149 - CH161)</li> <li>802.11b: 1, 2, 5.5, 11 Mbps</li> </ul>
	<ul> <li>802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)</li> <li>802.11ac : MCS0 ~ MCS9, (1SS) (20MHz, 40MHz, and 80MHz)</li> </ul>
Modulation	Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM
Security <sup>1</sup>	<ul> <li>IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only</li> <li>AES-CCMP: 128 bit in hardware</li> <li>802.1x authentication</li> <li>WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.</li> <li>WPA2 certification</li> <li>IEEE 802.11i</li> <li>Cisco Certified Extensions, all versions through CCX4 and CCX Lite</li> <li>WAPI</li> </ul>
Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points
Output Power <sup>2</sup>	• 802.11b : +16dBm minimum
	• 802.11g : +14dBm minimum
	• 802.11a : +14dBm minimum
	• 802.11n HT20(2.4GHz) : +14dBm minimum
	<ul> <li>802.11n HT40(2.4GHz) : +12dBm minimum</li> <li>802.11n HT20(FCHz) : +14dBm minimum</li> </ul>
	• 802.11n HT20(5GHz) : +14dBm minimum

802.11n HT40(5GHz): +12dBm minimum

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# **Technical Specifications**

Power Consumption	<ul> <li>802.11ac 80MHz(5GHz) : +11dBm minimum Transmit: 2.0 W (max)</li> </ul>
	Receive: 1.6 W (max)
	Idle mode (PSP): 180 mW (WLAN Associated)
	Idle mode: 50 mW (WLAN unassociated)
	Connect Standby: 10 mW (WLAN+BT)
	Radio disabled: 5 mW
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode
Receiver Sensitivity <sup>3</sup>	802.11b, 1Mbps : -94dBm maximum
	802.11b, 11Mbps : -86dBm maximum
	802.11g, 6Mbps : -88dBm maximum
	802.11g, 54Mbps : -74dBm maximum
	802.11a, 6Mbps : -88dBm maximum
	802.11a, 54Mbps : -74dBm maximum
	802.11n, MCS07 : -69dBm maximum
	802.11n, MCS15 : -66dBm maximum
	802.11ac, 1SS, MCS-0 : -86dBm maximum
	802.11ac, 1SS, MCS-9 : -61dBm maximum
	802.11ac, 2SS, MCS-0 : -83dBm maximum
	802.11ac, 2SS, MCS-9 : -58dBm maximum
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure
	Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications
Form Factor	PCI-Express M.2 MiniCard
Dimensions	Type 2230 : 2.3 x 22.0 x 30.0 mm
	Or



# **Technical Specifications**

	Type 1630 : 2.3 x 16.0 x 30.0 mm	
Weight	Туре 2230 : 2.8g	
	Or	
	Туре 1630 : 2g	
Operating Voltage	3.3v +/- 9%	
Temperature	Operating Non-operating	14° to 158° F (–10° to 70° C) –40° to 176° F (–40° to 80° C)
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)
LED Activity	LED Amber – Radio OFF; LED White – Radio ON	

- 1. Check latest software/driver release for updates on supported security features.
- 2. Maximum output power may vary by country according to local regulations.
- 3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

#### HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology

Bluetooth Specification	4.0/4.1/4.2 Compliant
Frequency Band	2402 to 2480 MHz
Number of Available Channels	Legacy : 0~79 (1 MHz/CH)
	BLE : 0~39 (2 MHz/CH)
Data Rates and Throughput	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps
	BLE : 1 Mbps data rate; throughput up to 0.2 Mbps
	Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels
	Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.



Receiver Sensitivity	Modulation	0.01% BER	0.001% BER
Legacy	GFSK	-80 dBm	-70 dBm
	π/4-DQPSK	-80 dBm	-70 dBm
	8DPSK	-80 dBm	-70 dBm
Power Consumption	Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 17 mW		
Range	Legacy Up to 33 ft (10 m)		
	BLE Up to 99 ft (30 m)		
Electrical Interface	USB 2.0 compliant		
Bluetooth Software Supported	Microsoft Windows Bluetooth Software		
Link Topology			
Electrical Interface	Point to Point, Multipoint Pico Nets up to 7 slaves		
Bluetooth Software Supported	Full support of Bluetooth Security Provisions		
Security			
Power Management	Microsoft Windows ACPI, and USB Bus Support		
Certifications	Self-configurable to optimize power conservation in all operating modes, including Standby, Hold, Park, and Sniff		
Security	All necessary regulatory approvals for supported countries, including		
Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.249		
Bluetooth Profiles Supported			
Power Management	ETS 300 328, ETS 300 826		
Certifications	Low Voltage Directive IEC950		
Certifications	UL, CSA, and CE Mark	ĸ	
	Serial Port Profile (S	PP) <sup>1.2</sup>	



# Technical Specifications

Bluetooth Profiles Supported	Service Discovery Application Profile (SDAP)
	Dial-Up Networking (DUN) <sup>1.1</sup>
	Generic Object Exchange Profile (GOEP) <sup>1,2</sup>
	Object Push Profile (OPP) <sup>1,2</sup>
	Hard Copy Cable Replacement (HCRP) <sup>1,2</sup>
	Personal Area Networking Profile (PAN) <sup>1.0</sup>
	Human Interface Device Profile (HID) <sup>1.0</sup>
	Hands Free Profile (HFP) <sup>1.5/1.6</sup>
	Advanced Audio Distribution Profile (A2DP) <sup>1.3</sup>
	Audio Video Remote Control Profile (AVRCP) 1.3/1.4

Bluetooth V4.1/V4.2 support	V4.1: ESR5/6/7 compliant
feature	

V4.2: ESR8 compliant, LE Secure Connection – Basic.

#### Realtek 802.11b/g/n (1x1) and Bluetooth® 4.0 Combo

Wireless LAN Standards	IEEE 802.11a
	IEEE 802.11b IEEE 802.11g
	IEEE 802.11n
	IEEE 802.11ac
Interoperability	Wi-Fi certified
Frequency Band	802.11b/g/n
	• 2.402 – 2.482 GHz Note:

The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

802.11a/n



Data Rates	<ul> <li>4.9 – 4.95 GHz (Japan)</li> <li>5.15 – 5.25 GHz</li> <li>5.25 – 5.35 GHz</li> <li>5.47 – 5.725 GHz</li> <li>5.825 – 5.850 GHz Note: Indonesia only supports 5.725 - 5.825 GHz (CH149 - CH161) </li> <li>802.11b: 1, 2, 5.5, 11 Mbps</li> <li>802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>802.11a: MCS 0 ~ MCS 15, (20MHz, and 40MHz)</li> <li>802.11ac : MCS0 ~ MCS9, (1SS) (20MHz, 40MHz, and 80MHz)</li> </ul>
Modulation	Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM
Security <sup>1</sup> Network Architecture	<ul> <li>IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only</li> <li>AES-CCMP: 128 bit in hardware</li> <li>802.1x authentication</li> <li>WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.</li> <li>WPA2 certification</li> <li>IEEE 802.11i</li> <li>Cisco Certified Extensions, all versions through CCX4 and CCX Lite</li> <li>WAPI</li> <li>Ad-hoc (Peer to Peer)</li> </ul>
Models	Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points
Output Power <sup>2</sup>	• 802.11b : +16dBm minimum
	• 802.11g : +14dBm minimum
	• 802.11a : +14dBm minimum
	• 802.11n HT20(2.4GHz) : +14dBm minimum
	• 802.11n HT40(2.4GHz) : +12dBm minimum
	• 802.11n HT20(5GHz) : +14dBm minimum

802.11n HT40(5GHz): +12dBm minimum

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Power Consumption	<ul> <li>802.11ac 80MHz(5GHz) : +11dBm minimum Transmit: 2.0 W (max)</li> </ul>
	Receive: 1.6 W (max)
	Idle mode (PSP): 180 mW (WLAN Associated)
	Idle mode: 50 mW (WLAN unassociated)
	Connect Standby: 10 mW (WLAN+BT)
	Radio disabled: 5 mW
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode
Receiver Sensitivity <sup>3</sup>	802.11b, 1Mbps : -94dBm maximum
	802.11b, 11Mbps : -86dBm maximum
	802.11g, 6Mbps : -88dBm maximum
	802.11g, 54Mbps : -74dBm maximum
	802.11a, 6Mbps : -88dBm maximum
	802.11a, 54Mbps : -74dBm maximum
	802.11n, MCS07 : -69dBm maximum
	802.11n, MCS15 : -66dBm maximum
	802.11ac, 1SS, MCS-0 : -86dBm maximum
	802.11ac, 1SS, MCS-9 : -61dBm maximum
	802.11ac, 2SS, MCS-0 : -83dBm maximum
	802.11ac, 2SS, MCS-9 : -58dBm maximum
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure
	Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications
Form Factor	PCI-Express M.2 MiniCard
Dimensions	Type 2230 : 2.3 x 22.0 x 30.0 mm
	Or



#### **Technical Specifications**

	Type 1630 : 2.3 x 16.0 x 30.0 mm	
Weight	Type 2230 : 2.8g	
	Or	
	Туре 1630 : 2g	
Operating Voltage	3.3v +/- 9%	
Temperature	Operating Non-operating	14° to 158° F (–10° to 70° C) –40° to 176° F (–40° to 80° C)
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)
LED Activity	LED Amber – Radio OFF;	LED White – Radio ON

- 4. Check latest software/driver release for updates on supported security features.
- 5. Maximum output power may vary by country according to local regulations.
- 6. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

#### HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology

Bluetooth Specification	4.0/4.1/4.2 Compliant
Frequency Band	2402 to 2480 MHz
Number of Available Channels	Legacy : 0~79 (1 MHz/CH)
	BLE : 0~39 (2 MHz/CH)
Data Rates and Throughput	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps
	BLE : 1 Mbps data rate; throughput up to 0.2 Mbps
	Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels
	Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.



Receiver Sensitivity	Modulation	0.01% BER	0.001% BER
Legacy	GFSK	-80 dBm	-70 dBm
	π/4-DQPSK	-80 dBm	-70 dBm
	8DPSK	-80 dBm	-70 dBm
Power Consumption	L Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 1	7 mW	11
Range	Legacy Up to 33 ft (10 m)		
	BLE Up to 99 ft (30 n	n)	
Electrical Interface	USB 2.0 compliant		
Bluetooth Software Supported	Microsoft Windows I	Bluetooth Softwar	2
Link Topology			
Electrical Interface	Point to Point, Multi	point Pico Nets up	to 7 slaves
Bluetooth Software Supported	Full support of Bluetooth Security Provisions		
Security			
Power Management	Microsoft Windows A	ACPI, and USB Bus	Support
Certifications	Self-configurable to optimize power conservation in all operating modes, including Standby, Hold, Park, and Sniff		
Security	All necessary regulatory approvals for supported countries, including		
Certifications	FCC (47 CFR) Part 15	C, Section 15.247	& 15.249
Bluetooth Profiles Supported			
Power Management	ETS 300 328, ETS 30	00 826	
Certifications	Low Voltage Directive IEC950		
Certifications	UL, CSA, and CE Mark		
	Serial Port Profile (S	PP) <sup>1.2</sup>	



## Technical Specifications

Bluetooth Profiles Supported	Service Discovery Application Profile (SDAP)
	Dial-Up Networking (DUN) <sup>1.1</sup>
	Generic Object Exchange Profile (GOEP) <sup>1,2</sup>
	Object Push Profile (OPP) <sup>1,2</sup>
	Hard Copy Cable Replacement (HCRP) <sup>1,2</sup>
	Personal Area Networking Profile (PAN) <sup>1.0</sup>
	Human Interface Device Profile (HID) <sup>1.0</sup>
	Hands Free Profile (HFP) <sup>1.5/1.6</sup>
	Advanced Audio Distribution Profile (A2DP) <sup>1.3</sup>
	Audio Video Remote Control Profile (AVRCP) 1.3/1.4

Bluetooth V4.1/V4.2 support	V4.1: ESR5/6/7 compliant
feature	

V4.2: ESR8 compliant, LE Secure Connection – Basic.

#### Intel® Dual Band Wireless-AC 7265 802.11a/b/g/n/ac (2x2) WiFi and Bluetooth® 4.2 Combo

Wireless LAN Standards	IEEE 802.11a
	IEEE 802.11b
	IEEE 802.11g
	IEEE 802.11n
	IEEE 802.11ac
Interoperability	Wi-Fi certified
Frequency Band	802.11b/g/n
	• 2.402 – 2.482 GHz Note:

The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

802.11a/n



Data Rates	<ul> <li>4.9 – 4.95 GHz (Japan)</li> <li>5.15 – 5.25 GHz</li> <li>5.25 – 5.35 GHz</li> <li>5.47 – 5.725 GHz</li> <li>5.825 – 5.850 GHz Note: Indonesia no support this band)</li> <li>802.11b: 1, 2, 5.5, 11 Mbps</li> <li>802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>802.11a: MCS 0 ~ MCS 15, (20MHz, and 40MHz)</li> <li>802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)</li> </ul>
Modulation	Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM
Security <sup>1</sup> Network Architecture Models	<ul> <li>IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only</li> <li>AES-CCMP: 128 bit in hardware</li> <li>802.1x authentication</li> <li>WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.</li> <li>WPA2 certification</li> <li>IEEE 802.11i</li> <li>Cisco Certified Extensions, all versions through CCX4 and CCX Lite</li> <li>WAPI</li> <li>Ad-hoc (Peer to Peer)</li> <li>Infrastructure (Access Point Required)</li> </ul>
Roaming	IEEE 802.11 compliant roaming between access points
Output Power <sup>2</sup>	<ul> <li>802.11b : +16dBm minimum</li> <li>802.11g : +14dBm minimum</li> <li>802.11a : +14dBm minimum</li> <li>802.11n HT20(2.4GHz) : +14dBm minimum</li> <li>802.11n HT40(2.4GHz) : +12dBm minimum</li> <li>802.11n HT20(5GHz) : +12dBm minimum</li> <li>802.11n HT40(5GHz) : +12dBm minimum</li> </ul>
Power Consumption	Transmit: 2.0 W (max)



## **Technical Specifications**

	Receive: 1.6 W (max)
	Idle mode (PSP): 180 mW (WLAN Associated)
	Idle mode: 50 mW (WLAN unassociated)
	Connect Standby: 10 mW (WLAN+BT)
	Radio disabled: 5 mW
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode
Receiver Sensitivity <sup>3</sup>	802.11b, 1Mbps : -94dBm maximum
	802.11b, 11Mbps : -86dBm maximum
	802.11g, 6Mbps : -88dBm maximum
	802.11g, 54Mbps : -74dBm maximum
	802.11a, 6Mbps : -88dBm maximum
	802.11a, 54Mbps : -74dBm maximum
	802.11n, MCS07 : -69dBm maximum
	802.11n, MCS15 : -66dBm maximum
	802.11ac, 1SS, MCS-0 : -86dBm maximum
	802.11ac, 1SS, MCS-9 : -61dBm maximum
	802.11ac, 2SS, MCS-0 : -83dBm maximum
	802.11ac, 2SS, MCS-9 : -58dBm maximum
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure
	Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications
Form Factor	PCI-Express M.2 MiniCard
Dimensions	Type 2230 : 2.3 x 22.0 x 30.0 mm
	Or Type 1630 : 2.3 x 16.0 x 30.0 mm
Weight	Туре 2230 : 2.8g



Not all configuration components are available in all regions/countries. c05240727 – DA 15673– World Wide – Version 8 – September 12, 2018

## Technical Specifications

	Or	
	Туре 1630 : 2g	
Operating Voltage	3.3v +/- 9%	
Temperature	Operating Non-operating	14° to 158° F (–10° to 70° C) –40° to 176° F (–40° to 80° C)
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)
LED Activity	LED Amber – Radio OFF;	LED White – Radio ON

- 7. Check latest software/driver release for updates on supported security features.
- 8. Maximum output power may vary by country according to local regulations.
- 9. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology

Bluetooth Specification	4.0/4.1/4.2 Compliant
Frequency Band	2402 to 2480 MHz
Number of Available Channels	Legacy : 0~79 (1 MHz/CH)
	BLE : 0~39 (2 MHz/CH)
Data Rates and Throughput	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps
	BLE : 1 Mbps data rate; throughput up to 0.2 Mbps
	Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels
	Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.

Receiver Sensitivity         Modulation         0.01% BER         0.001% BER	
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cirications				
Legacy	GFSK	-80 dBm	-70 dBm	
	π/4-DQPSK	-80 dBm	-70 dBm	
	8DPSK	-80 dBm	-70 dBm	
Power Consumption	Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 17 mW			
Range	Legacy Up to 33 ft (	10 m)		
	BLE Up to 99 ft (30	m)		
Electrical Interface	USB 2.0 compliant			
Bluetooth Software Supported	Microsoft Windows	Bluetooth Softwar	e	
Link Topology				
Electrical Interface	Point to Point, Multipoint Pico Nets up to 7 slaves			
Bluetooth Software Supported	Full support of Bluetooth Security Provisions			
Security				
Power Management	Microsoft Windows ACPI, and USB Bus Support			
Certifications	Self-configurable to optimize power conservation in all operating modes, including Standby, Hold, Park, and Sniff			
Security	All necessary regulatory approvals for supported countries, including:			
Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.249			
Bluetooth Profiles Supported				
Power Management	ETS 300 328, ETS 300 826			
Certifications	Low Voltage Directive IEC950			
	UL, CSA, and CE Mar	k		
Certifications Bluetooth Profiles Supported	Serial Port Profile (SPP) <sup>1,2</sup> Service Discovery Application Profile (SDAP) Dial-Up Networking (DUN) <sup>1,1</sup> Generic Object Exchange Profile (GOEP) <sup>1,2</sup> Object Push Profile (OPP) <sup>1,2</sup> Hard Copy Cable Replacement (HCRP) <sup>1,2</sup>			



**Technical Specifications** 

# Personal Area Networking Profile (PAN)<sup>1.0</sup> Human Interface Device Profile (HID)<sup>1.0</sup> Hands Free Profile (HFP)<sup>1.5/1.6</sup> Advanced Audio Distribution Profile (A2DP)<sup>1.3</sup> Audio Video Remote Control Profile (AVRCP)<sup>1.3/1.4</sup> Bluetooth V4.1/V4.2 support V4.1: ESR5/6/7 compliant feature V4.2: ESR8 compliant, LE Secure Connection – Basic.

#### POWER

45 W AC Adaptor		
Dimensions		95.0x40.0x26.5mm
Weight		unit: 200g +/- 10g
	Input Efficiency	87.74 % at 115 Vac and 88.4 % at 230Vac
Input	Input Frequency Range	47 ~ 63 Hz
	Input AC current	Max. 1.4 A at 90 Vac
	Output Power	45W
Output	DC Output	19.5V
σατρατ	Hold-up Time	5ms at 115 Vac input
	<b>Output Over Current Protection</b>	<8.0A
DC Plug		4.5mm Barrel Type
	Operating Temperature	32°F to 95°F (0°to 35°C)
	Non-operating (storage) Temperature	-4ºF to 185ºF (-20ºto 85ºC)
Environmental Design	Altitude	0 to 16,400 ft (0 to 5000m)
	Humidity	20% to 95%
	Storage Humidity	10% to 95%



#### **Technical Specifications**

#### EMI and Safety Certifications

45 W 2 Prong AC Adaptor

\*CE Mark - full compliance with LVD and EMC directives \* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.

\* MTBF - over 200,000 hours at 25°C ambient condition.

Dimensions		95.0x40.0x26.5mm
Weight		unit: 200g +/- 10g
	Input Efficiency	87.74 % at 115 Vac and 88.4 % at 230Vac
Input	Input Frequency Range	47 ~ 63 Hz
	Input AC current	Max. 1.4 A at 90 Vac
	Output Power	45W
0	DC Output	19.5V
Output	Hold-up Time	5ms at 115 Vac input
	<b>Output Over Current Protection</b>	<8.0A
DC Plug		4.5mm Barrel Type
	Operating Temperature	32°F to 95°F (0°to 35°C)
	Non-operating (storage) Temperature	-4°F to 185°F (-20°to 85°C)
Environmental Design	Altitude	0 to 16,400 ft (0 to 5000m)
	Humidity	20% to 95%
	Storage Humidity	10% to 95%

**EMI and Safety Certifications** 

\*CE Mark - full compliance with LVD and EMC directives \* Worldwide safety standards - IEC60950, EN60950, UL60950, Class2, SELV; Agency approvals - C-UL-US, PSE \* MTBF - over 200,000 hours at 25°C ambient condition.

65 W AC Adaptor		
Dimensions		107.0x47.0x30.0mm
Weight		unit: 250g +/- 10g
	Input Efficiency	88.0 % at 115 Vac and 89.0 % at 230Vac
Input	Input Frequency Range	47 ~ 63 Hz
	Input AC current	Max. 1.7 A at 90 Vac
Output	Output Power	65W

Not all configuration components are available in all regions/countries. c05240727 – DA 15673– World Wide – Version 8 – September 12, 2018

	DC Output	19.5V
	Hold-up Time	5ms at 115 Vac input
	Output Over Current Protection	<11.0A
DC Plug		4.5mm Barrel Type
	Operating Temperature	32°F to 95°F (0°to 35°C)
	Non-operating (storage) Temperature	-4°F to 185°F (-20°to 85°C)
Environmental Design	Altitude	0 to 16,400 ft (0 to 5000m)
	Humidity	20% to 95%
	Storage Humidity	10% to 95%
EMI and Safety Certification	DNS	*CE Mark - full compliance with LVD and EMC directives * Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. * MTBF - over 200,000 hours at 25°C ambient condition.

65 W EM AC Adaptor		
Dimensions		102.0x55.0x30.0mm
Weight		unit: 350g +/- 10g
	Input Efficiency	87.0 % at 115 Vac and 230Vac
Input	Input Frequency Range	47 ~ 63 Hz
	Input AC current	Max. 1.7 A at 90 Vac
	Output Power	65W
Quesue	DC Output	19.5V
Output	Hold-up Time	5ms at 115 Vac input
	<b>Output Over Current Protection</b>	<11.0A
DC Plug		4.5mm Barrel Type
	Operating Temperature	32°F to 95°F (0°to 35°C)
	Non-operating (storage) Temperature	-4ºF to 185ºF (-20ºto 85ºC)
Environmental Design	Altitude	0 to 16,400 ft (0 to 5000m)
	Humidity	20% to 95%
	Storage Humidity	10% to 95%



#### **Technical Specifications**

EMI	and	Safety	Certifications
	ana	Juicty	certifications

\*CE Mark - full compliance with LVD and EMC directives \* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. \* MTBF - over 200,000 hours at 25°C ambient condition.

90 W AC Adaptor Dimensions 127.0x51.0x30.0mm Weight unit: 350g +/- 10g 88% min at 115V and 89% min at 230V Input Efficiency **Input Frequency Range** Input 47 ~ 63 Hz **Input AC current** 1.5 A at 90 VAC and maximum load **Output Power** 90W **DC Output** 19.5V Output **Hold-up Time** 5ms at 115 Vac input **Output Over Current Protection** <11.0A DC Plug 4.5mm Barrel Type **Operating Temperature** 32°Fto 95°F (0°to 35°C) Non-operating (storage) Temperature -4°Fto 185°F (-20°to 85°C) **Environmental Design** Altitude 0 to 16,400 ft (0 to 5000m) Humiditv 5% to 95% **Storage Humidity** 5% to 95%

**EMI and Safety Certifications** 

\*CE Mark - full compliance with LVD and EMC directives \* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. \* MTBF - over 100,000 hours at 25°C ambient condition.



# Technical Specifications

HP 3-cell, Long Life 48 WHr Li-ion	<b>Dimensions</b> (H x W x L)	15.05. x177.55x94.55 mm	
	Weight		0.25 kg (0.55lb)
	Cells/Type		3cell Lithium-Ion
		Voltage	11.4V/ 10.95V
	Energy	Amp-hour capacity	4.212Ah /4.385Ah
		Watt-hour capacity	48Wh
		Operating (Charging)	32° to 113° F (0° to 45° C)
	Temperature	Operating (Discharging)	14° to 122° F(-10° to 60° C)
		Non-operating	-4° to 122° F (-20° to 60° C)
	Battery Re-Charge Time	System in OFF or Standby Mode	<3 hours
	Fuel Gauge LED		No
	Warranty		Batteries have a default one year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform.
	Optional Travel Battery Available		No

#### SECURITY

<b>HP Fingerprint Reader</b> (optional)	Mobile Voltage Operation	3.0V-3.6V
	Operating Temperature	14° – 167°F (-10° – 75°C)
	Current consumption	Imaging: 36 mA (typical) Low latency wakeup: 950 µA (typical) USB Suspend: 220 µA (max)
	ESD Resistance	IEC 61000-4-2 Level 4B (±15KV)
	Detection Matrix	508 DPI resolution, 256 levels of grayscale 200 pixel wide fingerprint image (10mm) 16.5mm x 3 mm (sensor area)



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Smart Card Reader	Smart card standard	PC/SC 2.0 for Wi	ndows smart card standard
	<b>Dimensions</b> (L x W x H)	0.41x 0.08 x 0.32 in (10.5 x 2 x 8.2 mm)	
	Smart Card support	ISO 7816 Class A, B, and C (5V/3V/1.8V) card	
	Smart Card Interface	Support I2C mer	rface with T = 0 and T = 1 support nory card, SLE4418, SLE4428, SLE4432, SLE4442, SLE4436, 36, AT88SC1608, AT45D041 card and AT45DB041 card via M
	Operating systems	No driver is requ system.	ired for this device. Native support is provided by the operating
	Power	Normal Mode	With card present, before being suspended: 40.9 mA Without card present, before being suspended: 33.16 mA After being suspended with smart card present: 380 µA After being suspended without smart card present: 380 µA
		Power Saving Mode	With card present, before being suspended: 40.6 mA Without card present: 380 μA After being suspended with smart card present: 380 μA
	Features	<ul> <li>Suppor</li> <li>Suppor</li> <li>Suppor</li> <li>SLE443</li> <li>SLE553 <ul> <li>card via</li> <li>Suppor</li> <li>Implem</li> <li>Mass</li> </ul> </li> <li>Storage</li> <li>Built-in</li> <li>Suppor</li> <li>iManufa <ul> <li>accessi</li> <li>EEPROI</li> <li>Suppor</li> </ul></li></ul>	t single slot t TO, T1 protocol t I2C memory card, SLE4418, SLE4428, SLE4432, SLE4442, i6, i6, SLE6636, AT88SC1608, AT45D041 card and AT45DB041 a external EEPROM t ISO7816 Class A, B and C (5V/3V/1.8V) card bented as an USB full speed device with bulk transfer endpoint, e endpoint PLL for USB and Smart Card clocks requirement t EEPROM for USB descriptors customization (PID/VID/ acturer/iProduct/Serial Number), Direct Web Page Link, and ng memory card module. M programmable via USB interface t software update for memory card module t Direct Web Page Link via configuration in external EEPROM t short APDU and extended APDU tible with Microsoft USB-CCID driver t remote wake up through inserting card/removing card t USB selective suspend t Power Saving Mode (Using one pin to select between I/PWR Saving Mode) t card power over current protection mechanism resonator. t USB LPM (Link Power Management) features. ded clock source.



#### **ENVIRONMENTAL**

#### HP ProBook 645 G3 Notebook PC

Eco-Label Certifications & declarations System Configuration	<ul> <li>This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:         <ul> <li>IT ECO declaration</li> <li>US ENERGY STAR<sup>®</sup></li> <li>EPEAT <gold> registered in the United States. See http://www.epeat.net for registration status in your country.</gold></li> </ul> </li> <li>The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook".</li> </ul>		
Energy Consumption (in accordance with US ENERGY STAR® test method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Short idle)	8.24 W	8.70 W	8.77 W
Normal Operation (Long idle)	6.84 W	7.60 W	6.70 W
Sleep	0.48 W	0.59 W	0.48 W
Off	0.29 W	0.38 W	0.29 W
	family. HP computers ma Environmental Protection family does not offer ENE	rked with the ENERGY STAR® n Agency (EPA) ENERGY STA RGY STAR® compliant configued for the configues of the	ompliant product if offered within the model <sup>9</sup> Logo are compliant with the applicable U.S. R <sup>®</sup> specifications for computers. If a model urations, then energy efficiency data listed is Irive, a high efficiency power supply, and a



Heat Dissipation*	115VAC, 60Hz 230VAC, 50Hz		100VAC, 50Hz		
Normal Operation (Short idle)	28 BTU/hr	30 BTU/hr	30 BTU/hr		
Normal Operation (Long idle)	23 BTU/hr	26 BTU/hr	23 BTU/hr		
Sleep	2 BTU/hr	2 BTU/hr	2 BTU/hr		
Off	1 BTU/hr	1 BTU/hr	1 BTU/hr		
	*NOTE: Heat dissipation is calculated based on thattained for one hour.		the measured watts, assuming the service level is		
Declared Noise	Sound Power		Sound Pressure		
Emissions (in accordance with ISO 7779 and ISO 9296)	(L <sub>WAd</sub> , bels)		(L <sub>pAm</sub> , decibels)		
Typically Configured – Idle	2.8		20		
Fixed Disk – Random writes	3.2		20		
Batteries	This battery(s) in this product comply with EU Directive 2006/66/EC Batteries used in the product do not contain: Mercury greater the1ppm by weight Cadmium greater than 20ppm by weight		ctive 2006/66/EC		
	Battery size: CR2032 (coin cell) Battery type: Lithium				



Additional Information	dire • This (WE • This Drin • This www • Plas ISO • This	s product is in compliance with the Restrictions of H active - 2011/65/EC. 5 HP product is designed to comply with the Waste E EE) Directive – 2002/96/EC. 5 product is in compliance with California Propositio aking Water and Toxic Enforcement Act of 1986). 6 product is in compliance with the IEEE 1680 (EPEA w.epeat.net stics parts weighing over 25 grams used in the prod 1043. 6 product contains 0% post-consumer recycled plas 5 product is 94.4% recycle-able when properly dispo	Electrical and Electronic Equipment n 65 (State of California; Safe T) standard at the <gold> level, see uct are marked per ISO11469 and tic (by wt.)</gold>	
Packaging Materials	External:	PAPER/Corrugated	326 g	
	Internal:	PLASTIC/Polyethylene Expanded - EPE	42 g	
		PLASTIC/Polyethylene low density - LDPE	15 g	
		PLASTIC/Polypropylene - PP	4 g	
	The plastic	packaging material contains at least 50% recycled of	content.	
Material Usage	-			
	The plastic packaging material contains at least 50% recycled content.           The corrugated paper packaging materials contains at least 70% recycled content.           This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):           • Asbestos         • Certain Azo Colorants           • Certain Brominated Flame Retardants – may not be used as flame retardants in plastics           • Cadmium         • Chlorinated Hydrocarbons           • Chlorinated Hydrocarbons           • Chlorinated Paraffins           • Formaldehyde           • Halogenated Diphenyl Methanes           • Lead carbonates and sulfates           • Lead and Lead compounds           • Mercuric Oxide Batteries           • Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user.           • Ozone Depleting Substances           • Polybrominated Biphenyl (PBBs)           • Polybrominated Biphenyl (PCB)           • Polychlorinated Terphenyls (PCT)           • Polychlorinated Terphenyls applications.			



Packaging Usage	<ul> <li>HP follows these guidelines to decrease the environmental impact of product packaging:</li> <li>Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.</li> <li>Eliminate the use of ozone-depleting substances (ODS) in packaging materials.</li> <li>Design packaging materials for ease of disassembly.</li> <li>Maximize the use of post-consumer recycled content materials in packaging materials.</li> <li>Use readily recyclable packaging materials such as paper and corrugated materials.</li> <li>Reduce size and weight of packages to improve transportation fuel efficiency.</li> <li>Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.</li> </ul>
End-of-life Management and Recycling	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.
	The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.
HP, Inc. Corporate Environmental Information	For more information about HP's commitment to the environment: Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates: http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842 and http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf
	http://www.np.com/npinto/gtobatcitizenship/environment/pur/cert.pur

#### HP ProBook 655 G3 Notebook PC



Eco-Label Certifications	This product has received or is in the process of being certified to the following approvals and may			
& declarations	be labeled with one or more of these marks:			
System Configuration	<ul> <li>IT ECO declaration</li> <li>US ENERGY STAR<sup>®</sup></li> <li>EPEAT<sup>□</sup> Gold registered in the United States. See http://www.epeat.net for registration status in your country.</li> <li>The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook".</li> </ul>			
Energy Consumption (in accordance with US ENERGY STAR® test method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz	
Normal Operation (Short idle)	8.93 W	9.59 W	8.32 W	
Normal Operation (Long idle)	5.18 W 5.65 W		5.22 W	
Sleep	0.50 W	0.62 W	0.50 W	
Off	0.34 W	0.44 W	0.34 W	
	Note: Energy efficiency data listed is for an ENERGY STAR <sup>®</sup> compliant product if offered within the model family. HP computers marked with the ENERGY STAR <sup>®</sup> Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR <sup>®</sup> specifications for computers. If a model family does not offer ENERGY STAR <sup>®</sup> compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows <sup>®</sup> operating system.			
Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz	
Normal Operation (Short idle)	31 BTU/hr	33 BTU/hr	28 BTU/hr	
Normal Operation (Long idle)	18 BTU/hr	19 BTU/hr	18 BTU/hr	
Sleep	2 BTU/hr	2 BTU/hr	2 BTU/hr	



Off	1 BT	U/hr	2 BTU/hr		1 BTU/hr
	*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.				
Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)	(Lwad, bels) (Lpan				Pressure decibels)
Typically Configured – Idle	3.3 2			25	
Fixed Disk – Random writes	3.7			30	
Additional Information	Batteries used in the product do not contain: Mercury greater the1ppm by weight Cadmium greater than 20ppm by weight         Battery size: CR2032 (coin cell) Battery type: Lithium         • This product is in compliance with the Restrictions of Hazardous Substances (RoHS)				us Substances (RoHS)
	<ul> <li>directive - 2011/65/EC.</li> <li>This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.</li> <li>This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).</li> <li>This product is in compliance with the IEEE 1680 (EPEAT) standard at the gold level, see www.epeat.net</li> <li>Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.</li> <li>This product contains 0% post-consumer recycled plastic (by wt.)</li> <li>This product is 94.9% recycle-able when properly disposed of at end of life.</li> </ul>				
Packaging Materials	External:	I: PAPER/Corrugated		329 g	
	Internal:       PLASTIC/Expanded Polyethylene - EPE         PLASTIC/Polyethylene low density - LDPE         PLASTIC/Polypropylene - PP         The plastic packaging material contains at least 50% recycled conternation		y - LDPE 50% recycled content		
Material Usage	The corrugated paper packaging materials contains at least 70% recycled content.This product does not contain any of the following substances in excess of regulatory limits (refertheHPGeneralSpecificationfortheEnvironment			ss of regulatory limits (refer to	



<ul> <li>http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pd</li> <li>Asbestos</li> </ul>	
<ul> <li>Certain Azo Colorants</li> <li>Certain Brominated Flame Retardants – may not be used as fl.</li> <li>Cadmium</li> <li>Chlorinated Hydrocarbons</li> <li>Chlorinated Paraffins</li> <li>Formaldehyde</li> <li>Halogenated Diphenyl Methanes</li> <li>Lead carbonates and sulfates</li> <li>Lead and Lead compounds</li> <li>Mercuric Oxide Batteries</li> <li>Nickel – finishes must not be used on the external surface des handled or carried by the user.</li> <li>Ozone Depleting Substances</li> <li>Polybrominated Biphenyl Ethers (PBBEs)</li> <li>Polybrominated Biphenyl Oxides (PBBOS)</li> <li>Polychlorinated Terphenyls (PCT)</li> <li>Polychlorinated Terphenyls (PCT)</li> <li>Polyvinyl Chloride (PVC) – except for wires and cables, and cer voluntarily removed from most applications.</li> <li>Radioactive Substances</li> <li>Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBT)</li> </ul>	signed to be frequently
Packaging Usage       HP follows these guidelines to decrease the environmental impact of p         Eliminate the use of heavy metals such as lead, chromium, me packaging materials.         Eliminate the use of ozone-depleting substances (ODS) in pac         Design packaging materials for ease of disassembly.         Maximize the use of post-consumer recycled content material         Use readily recyclable packaging materials such as paper and         Reduce size and weight of packages to improve transportation         Plastic packaging materials are marked according to ISO 1146	ercury and cadmium in kaging materials. ls in packaging materials. corrugated materials. n fuel efficiency.
End-of-life Management and RecyclingHewlett-Packard offers end-of-life HP product return and recycling areas. To recycle your product, please go to: http://www.hp.com/go/ nearest HP sales office. Products returned to HP will be recycled, no responsible manner.The EU WEEE directive (2002/95/EC) requires manufacturers to provide each product type for use by treatment facilities. This information (pro-	/reuse-recycle or contact your recovered or disposed of in a e treatment information for
Not all configuration components are available in all regions/countries.           c05240727 – DA 15673– World Wide – Version 8 – September 12, 2018	

# Technical Specifications

	instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.
HP, Inc. Corporate	For more information about HP's commitment to the environment:
Environmental Information	Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates: http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842 and http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf

**Country of Origin** TBD



### Options and Accessories (Sold separately and availability may vary by country.)

Category	Description	Part Number
Cases	HP Business Backpack	H5M90AA
	HP Business 4 Wheel Roller Case	Н5М9ЗАА
Docking	HP 3001pr USB 3.0 Port Replicator	F3S42AA
	HP USB-C Travel Dock	TOK29AA#ABA
	HP USB Travel Dock	ТОКЗОАА#АВА
	HP Ultraslim Docking Station	D9Y32AA#xxx
Input Device	HP Comfort Grip Wireless Mouse	H2L63AA
	HP 3-Button USB Laser Mouse	H4B81AA
	HP Ultra Mobile Wireless Mouse	H6F25AA#xxx
	HP Slim Bluetooth Mouse	F3J92AA#xxx
	HP Ultrathin Wireless Mouse	L9V78AA
	HP Stereo USB Headset	T1A67AA
Adapters	DisplayPort to HDMI Adapter	F3W43AA
	DisplayPort to DVI Adapter	F7W96AA
Power	HP 45W Smart AC Adapter (4.5mm)	H6Y88AA#xxx
	45W 2 Prong Power Adapter, 4.5mm	L6F60AA#ABJ
	HP 65W Smart AC Adapter	H6Y89AA#xxx
	HP Notebook Power Bank	N9F71AA
	HP USB External DVDRW Drive	F2B56AA
Security	HP Keyed Cable Lock 10mm	T1A62AA
	HP Docking Station Cable Lock	AU656AA#XXX
Monitors	HP ProDisplay P240va 23.8-inch Monitor	N3H14AA
	HP ProDisplay P232 23-inch Monitor	K7X31AA



#### Sumary of changes

Date of change	Version History		Description of change
December 5, 2016	V1 to V2	Launch	Quickspecs launched
January 3, 2017	V2 to V3	Update	Environmental info updated
January 13, 2017	V3 to V4	Update	Operating System and Processors Section updated (Win 7 disclaimer)
January 30, 2017	V4	Update	Battery Life Section updated
March 16, 2017	V4 to V5	Update	Memory and Display section updated
April 4, 2017	V5 to V6	Update	Battery Warranty updated and Processor Family added
October 2, 2017	V6 to V7	Update	Touchpoint manager removed
September 12, 2018	V7 to V8	Removed	Operating system section Windows 7

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